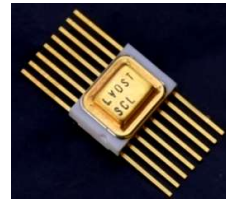


**HIGH SPEED**  
**QUAD LVDS DRIVER**  
**(SC1002-1)**  
**(Radiation Tolerant)**



**DATA SHEET**  
*Version 1.0, March 2019*



**Semi-Conductor Laboratory**  
**Government of India**  
**S.A.S. Nagar, Punjab-160071**  
**[www.scl.gov.in](http://www.scl.gov.in)**



**PRODUCT DESCRIPTION:**

The SC1002-1 is a quad, low-voltage, differential signaling (QLVDS) driver specifically designed and packaged for use in aerospace environments in a low-power and fast point-to-point baseband data transmission standard.

The intended application of these devices and signaling technique is point-to-point data transmission over controlled impedance media of approximately 100 ohm. The transmission media may be printed-circuit board traces, backplanes or cables.

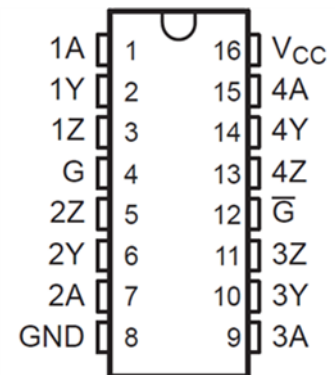
**FEATURES:**

- **Operating Power Supply 3.3V ±0.3V**
- **Cold sparing at LVDS output pins.**
- **LVTTL/CMOS logic input levels and LVDS output levels**
- **Compatible with ANSI/TIA/EIA-644 LVDS standard**
- **400 Mbps (200 MHz) switching rates**
- **±350 mV differential signaling**
- **Driver output at high impedance when disabled or with  $V_{DD} = 0$**
- **Power dissipation 26 mW Typical per driver at 200MHz ( $V_{DD}=3.3V$ )**
- **Propagation delay  $\leq 5$  nsec.**
- **Operating Temperature Range: -55°C to 125°C**
- **16 Pin CSOP /Customized package /Die**
- **Radiation Tolerant up to 200 KRad**
- **SET/SEL immune up to 50 MeV.cm<sup>2</sup>/mg**
- **Pin compatible with QLVDS driver LVDS31**
- **ESD protection level: HBM class-1 (< 1999V)**
- **Latch up current protection, ±100mA**
- **$\Theta_{JC} = 3.1^{\circ}C/Watt$**
- **SCL's 180nm CMOS Technology**

**PIN CONFIGURATION:**

Pin No.	Pin Name	Description
<b>16</b>	$V_{DD}$	+3.3V Supply
<b>8</b>	GND	Supply Ground
<b>4,12</b>	$G / \bar{G}$	Control inputs
<b>1, 7, 9, 15</b>	1A, 2A, 3A, 4A	Input Data 0 to 3.3V
<b>2, 6, 10, 14</b>	1Y, 2Y, 3Y, 4Y	LVDS O/P data (True)
<b>3, 5, 11, 13</b>	1Z, 2Z, 3Z, 4Z	LVDS O/P data (Complimentary)

Device Pin Description



Device Pin Diagram

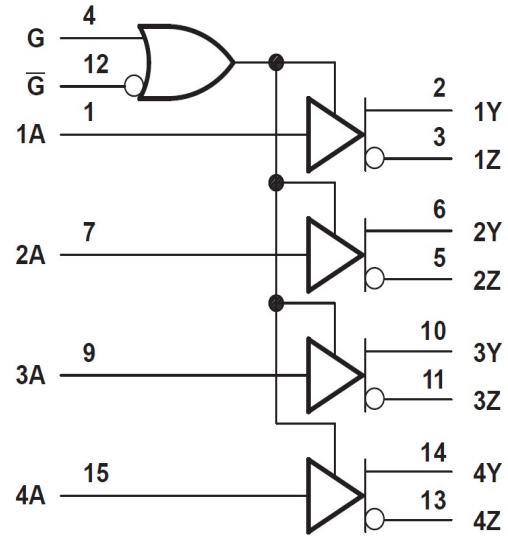


LOGIC DIAGRAM AND TRUTH TABLE:

Input	Enables		Outputs	
	A	G	Y	Z
H	H	X	H	L
L	H	X	L	H
H	X	L	H	L
L	X	L	L	H
X	L	H	Z	Z
Open	H	X	L	H
Open	X	L	L	H

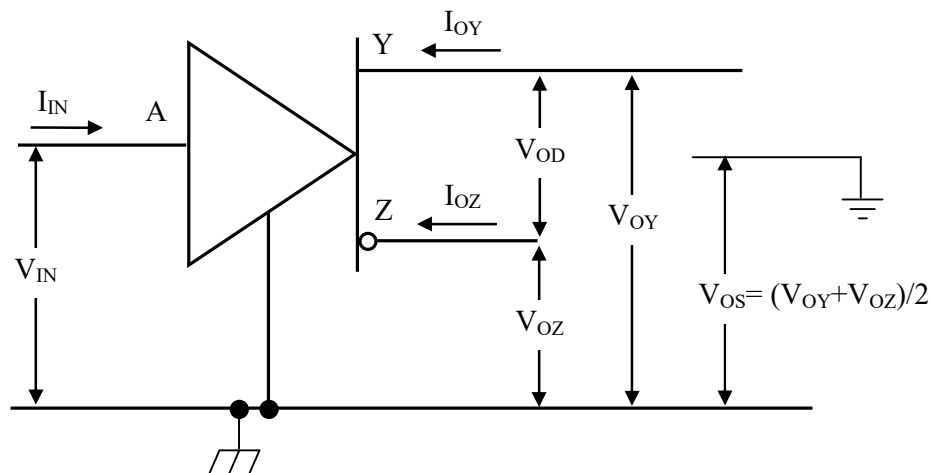
L=low level, H=high level,  
X=irrelevant, Z=high impedance

Functional Truth Table



Logic Diagram

TEST CIRCUIT:



Typical Test Circuit



**ABSOLUTE MAXIMUM RATINGS (1):**

Over operating free-air temperature range (unless otherwise noted)

PARAMETER	UNIT
Supply Voltage Range ( $V_{DD}$ )	-0.5V to 4.3V
Input Voltage Range ( $V_I$ )	-0.5V to $V_{DD} + 0.5V$
Max. Junction Temperature ( $T_J$ )	150°C
Storage Temperature Range ( $T_{STG}$ )	-65°C to 150°C

- (1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

**RECOMMENDED OPERATING CONDITIONS:**

Symbol	Parameter	Min.	Typ.	Max.	Unit
$V_{DD}$	Supply Voltage	3.0	3.3	3.6	V
$V_{IH}$	High Level Input Voltage	2.0	-	-	V
$V_{IL}$	Low Level Input Voltage	-	-	0.8	V
$T_A$	Operating Free Air Temperature	-55	-	+125	°C



## RT HIGH SPEED QLVDS DRIVER (SC1002-1)

### DC ELECTRICAL SPECIFICATIONS:

**Test condition:**  $D_{IN} = GND$  or  $V_{DD}$ ,  $R_L = 100\Omega$ ,  $V_{DD} = 3.3V \pm 0.3V$ ,  $T_{AMB} = -55^\circ C$  to  $125^\circ C$

Symbol	Parameters	Test Conditions	Pin	Min.	Typ.	Max.	Units
$V_{OD}$	Differential Output Voltage	$R_L = 100\Omega$	Y, Z	250	430	500	mV
$\Delta V_{OD}$	Change in Magnitude of $V_{OD}$ for Complementary Output State			-	-	50	mV
$V_{OS}$	Offset Voltage			1.125	1.2	1.375	V
$\Delta V_{OS}$	Change in Magnitude of $V_{OS}$ for Complementary Output States			-	-	50	mV
$V_{OH}$	Output Voltage High			1.25	1.45	1.625	V
$V_{OL}$	Output Voltage Low			0.875	1.02	1.25	V
$V_{IH}$	Input Voltage High		A	2	-	$V_{DD}$	V
$V_{IL}$	Input Voltage Low		A	GND	-	0.8	V
$I_{IH}$	High level input current	$V_{IH} = 2.0V$	A	-	7	$\pm 20$	$\mu A$
$I_{IL}$	Low level input current	$V_{IL} = 0.8V$		-	2.7	$\pm 10$	$\mu A$
$I_{DD}$ (static)	$I_{DDNL}$ (Driver enable)	No load $V_{IN} = 0.8V$ or $2V$	$V_{DD}$	-	4	10	mA
	$I_{DD}$ (Driver enable)	$R_L = 100\Omega$ $V_{IN} = 0.8V$ or $2V$		-	20	30	mA
	$I_{DDZ}$ (Driver disable)	$R_L = 100\Omega$ $V_{IN} = GND$ or $V_{DD}$		-	0.2	6	mA
$I_{OS}$	Short circuit o/p current (Driver Enabled)	$A = V_{DD}$ , $Y = 0V$ or $A = GND$ , $Z = 0V$	Y, Z	-	-4.5	-9	mA
		$A = V_{DD}$ , $V_{OD} = 0V$ (Y and Z shorted)		-	$\pm 4.5$	$\pm 12$	mA
$I_{OZ}$	High Impedance o/p current (Driver Disabled)	$V_{OUT} = 0$ or $2.4V$ ( $V_{DD} = 3.6V$ )		-	-	$\pm 10$	$\mu A$
$I_{O(OFF)}$	Power off o/p current, (cold sparing leakage)	$V_{DD} = GND$ $D_{IN} = V_{SS}$ or Float $V_{OUT} = 0$ or $2.4V$		-	-	$\pm 10$	$\mu A$

DC Electrical characteristics

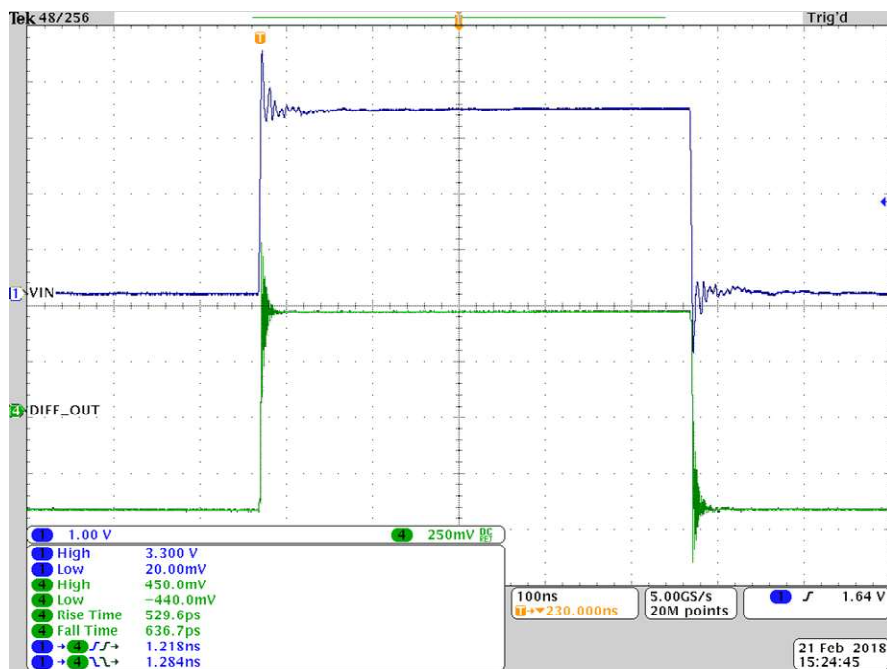
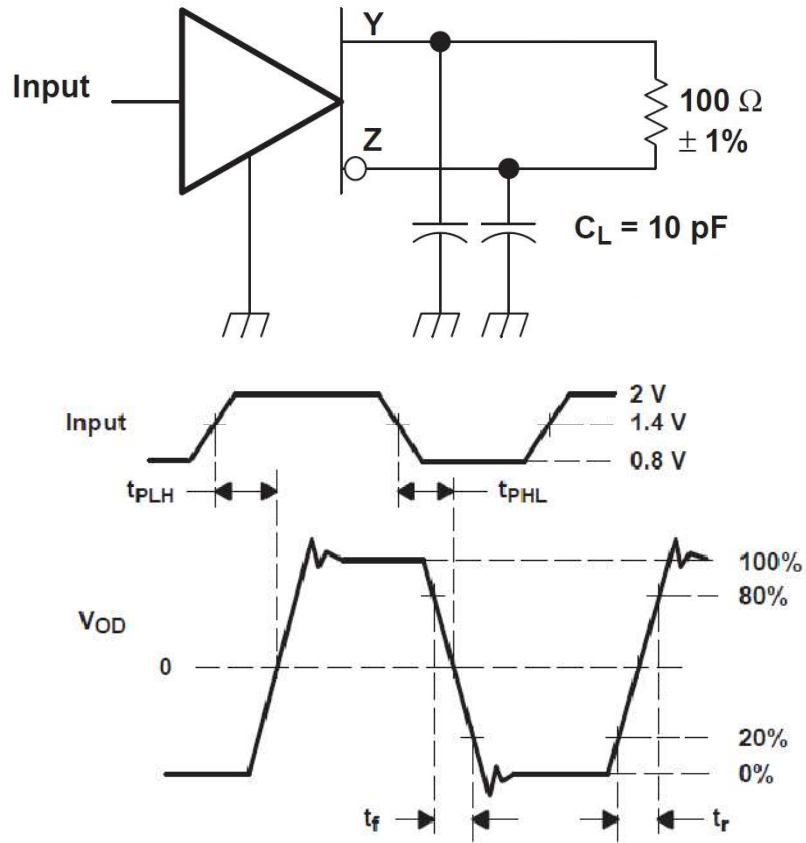
**AC ELECTRICAL SPECIFICATIONS:****Test condition:** $V_{DD}=3.3V$ ,  $D_{IN}=GND$  or  $V_{DD}$  @ 1 MHz,  $T_{AMB} = -55^{\circ}C$  to  $125^{\circ}C$ ,  $R_L=100\Omega$ ,  $C_L=10pF$ 

Symbol	Parameter	Min.	Typical	Max.	Units
$t_r$	VOD1 rise time (20% to 80%)	-	0.53	1.5	ns
$t_f$	VOD1 fall time (20% to 80%)	-	0.64	1.5	ns
$t_{PHLD}$	Differential Propagation delay	1.0	1.28	5	ns
$t_{PLHD}$	Differential Propagation delay	1.0	1.22	5	ns
$T_{SKD}$ $ t_{PHLD} - t_{PLHD} $	Differential Skew in delay	-	0.1	0.6	ns
$t_{PZH}$	high-impedance-to- high-level output	-	6	15	ns
$t_{PZL}$	high-impedance-to- low-level output	-	18	25	ns
$t_{PHZ}$	high-level-to- high-impedance output	-	5	15	ns
$t_{PLZ}$	low-level-to- high-impedance output	-	8	15	ns

Switching Characteristics



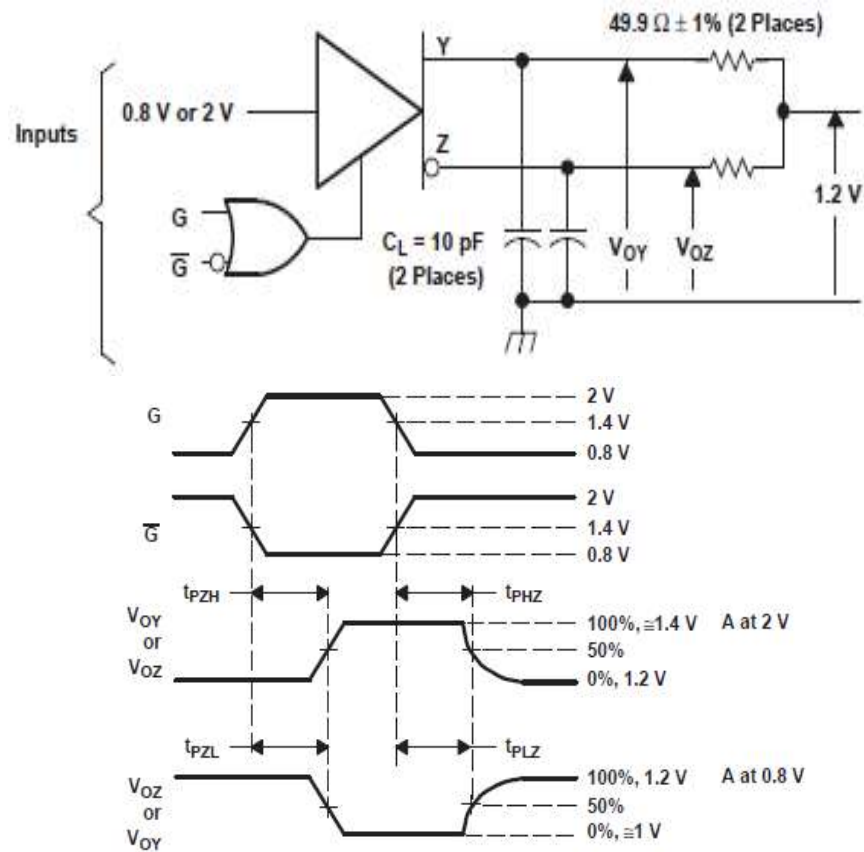
TEST CIRCUIT AND SWITCHING WAVEFORM :



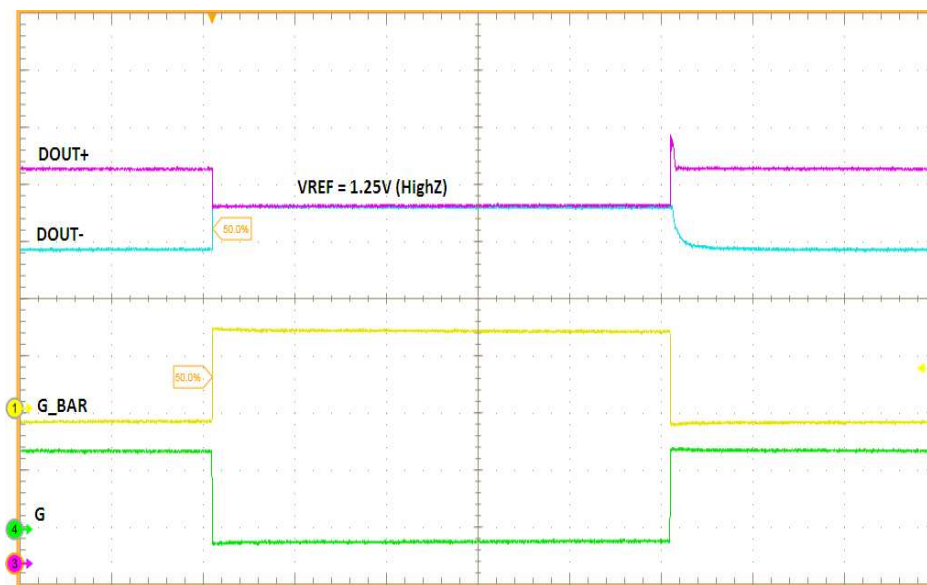
Waveform for Transition Time and Propagation Delay



TEST CIRCUIT AND SWITCHING WAVEFORM (HIGH IMPEDANCE) :



Input and Output waveform for driver high impedance state

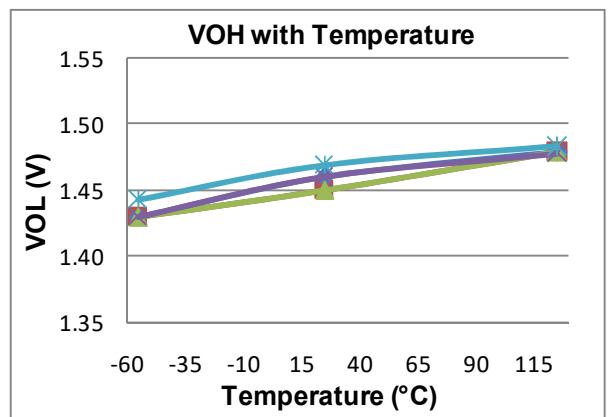
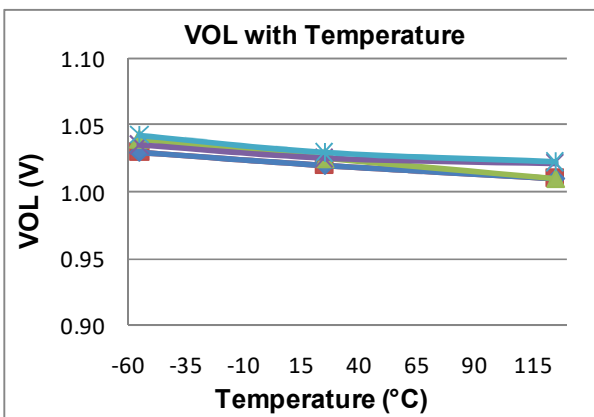
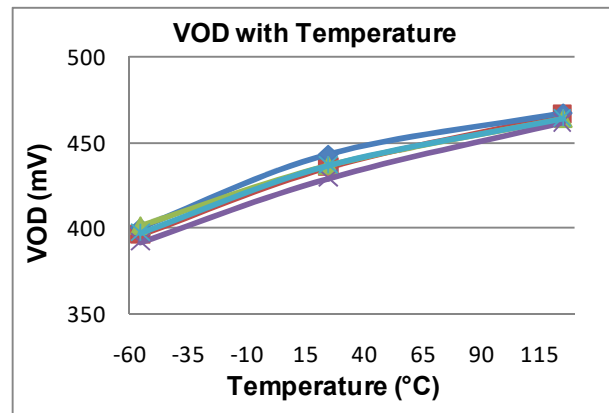
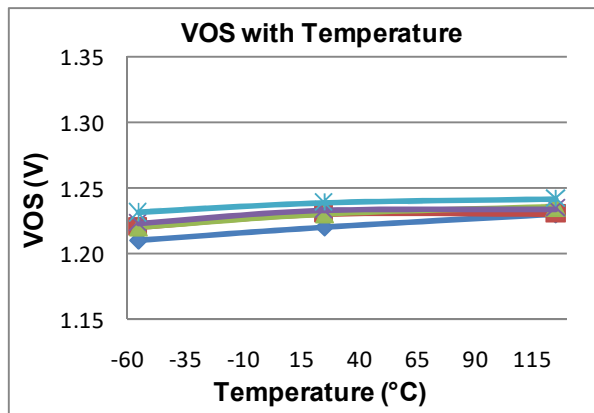
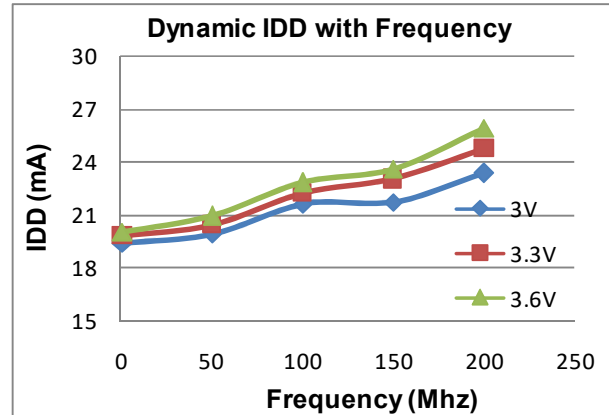
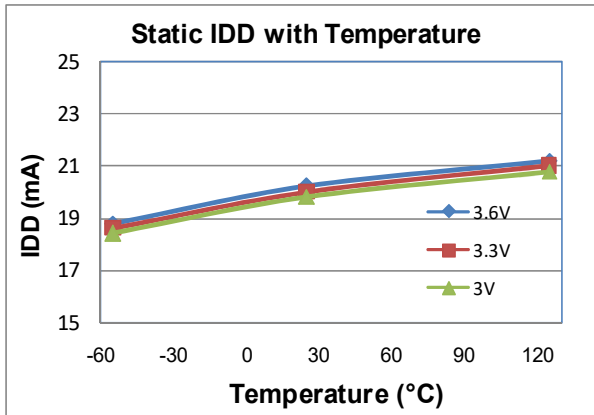


Test circuit and test waveform for high impedance functionality





DEVICE CHARACTERISTICS:



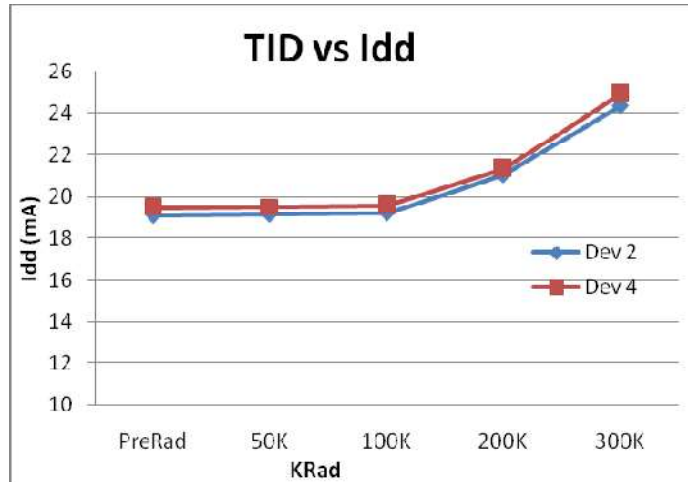
Typical Device Parameter Characteristics



**RADIATION CHARACTERISTICS:**

❖ **Total Ionization Dose (TID) Testing**

- TID testing of QLVDS Transmitter (SC1002-1) is performed for radiation level up to 300 KRad.
- No functional degradation and no significant change in device parameters such as IIL, IIH, VOL & VOH was observed up to 200KRad.
- Static supply current increases with radiation dose, shown in figure below.

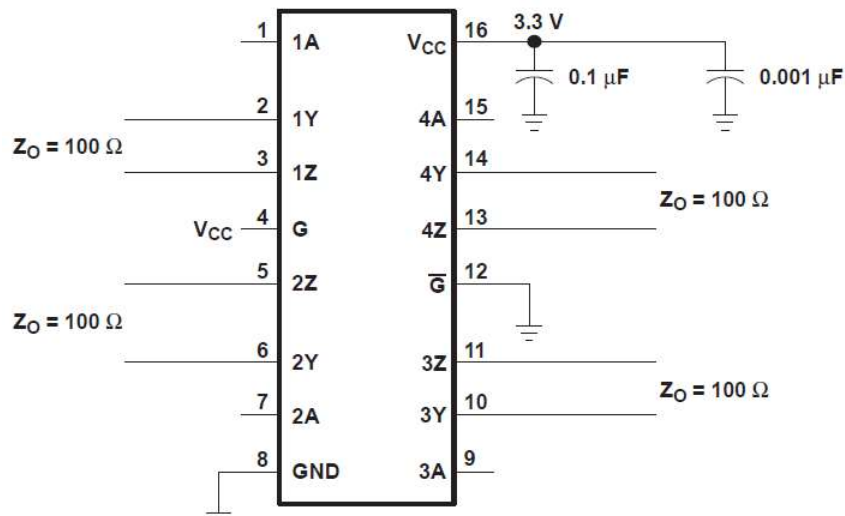


❖ **Single Event Effect (SEE) Testing**

SEE testing of QLVDS Transmitter (SC1002-1) is performed at two different LET energy ion beams Ni<sup>+</sup> (30 MeV-cm<sup>2</sup>/mg) and Ag<sup>+</sup> (50 MeV-cm<sup>2</sup>/mg) for a Fluence of 10<sup>6</sup> ions/cm<sup>2</sup>.

- No Single Event latch-up (SEL) was observed up to LET of 50 MeV-cm<sup>2</sup>/mg. Supply current (IDD) remains within specification throughout testing.
- No Single Event transient (SET) was observed up to LET of 50 MeV-cm<sup>2</sup>/mg.

**APPLICATION CIRCUIT:**



Typical Application Circuit of QLVDS driver

